

N & P-Channel 30-V (D-S) MOSFET

Key Features:

- Low $r_{DS(on)}$ trench technology
- Low thermal impedance
- Fast switching speed

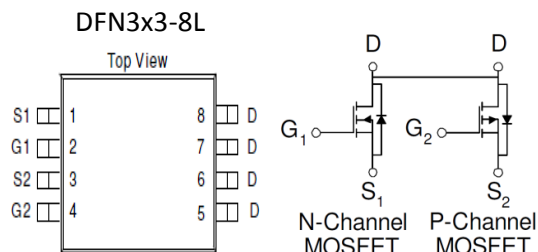
Typical Applications:

- DC/DC Conversion
- Motor Drives

PRODUCT SUMMARY		
V_{DS} (V)	$r_{DS(on)}$ (m Ω)	I_D (A)
30	50 @ $V_{GS} = 10V$	5.8
	83 @ $V_{GS} = 4.5V$	4.5
-30	72 @ $V_{GS} = -10V$	-4.9
	105 @ $V_{GS} = -4.5V$	-4.0



RoHS
COMPLIANT
HALOGEN
FREE



ABSOLUTE MAXIMUM RATINGS ($T_A = 25^\circ\text{C}$ UNLESS OTHERWISE NOTED)

Parameter	Symbol	Nch Limit	Pch Limit	Units	
Drain-Source Voltage	V_{DS}	30	-30	V	
Gate-Source Voltage	V_{GS}	± 20	± 20		
Continuous Drain Current ^a	I_D	$T_A = 25^\circ\text{C}$	5.8	-4.9	A
		$T_A = 70^\circ\text{C}$	4.2	-3.5	
Pulsed Drain Current ^b	I_{DM}	30	-30		
Continuous Source Current (Diode Conduction) ^a	I_S	3.2	-2.8	A	
Power Dissipation ^a	P_D	$T_A = 25^\circ\text{C}$	2.5	2.5	W
		$T_A = 70^\circ\text{C}$	1.3	1.3	
Operating Junction and Storage Temperature Range	T_J, T_{stg}	-55 to 150		$^\circ\text{C}$	

THERMAL RESISTANCE RATINGS

Parameter	Symbol	Maximum	Units
Maximum Junction-to-Ambient ^a	$R_{\theta JA}$	t \leq 10 sec	83
		Steady State	120

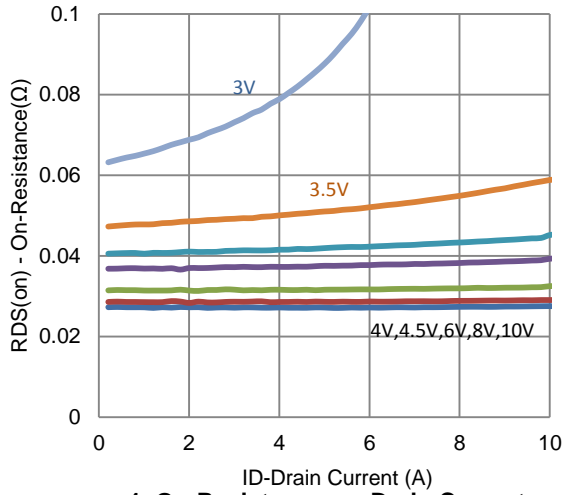
Notes

- Surface Mounted on 1" x 1" FR4 Board.
- Pulse width limited by maximum junction temperature

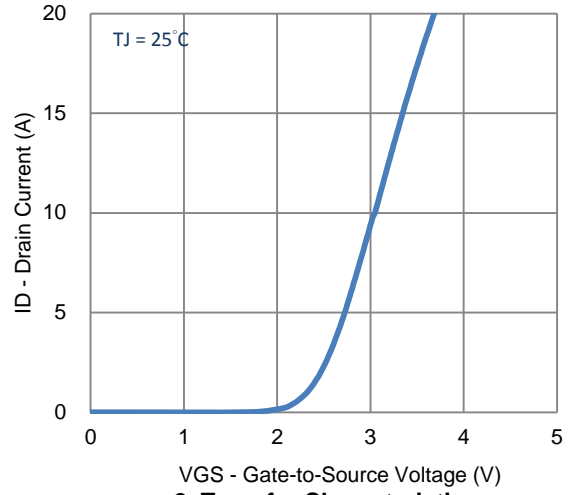
Electrical Characteristics

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Static						
Gate-Source Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = 250 \mu A$ (N-ch)	1			V
		$V_{DS} = V_{GS}, I_D = -250 \mu A$ (P-ch)	-1			V
Gate-Body Leakage	I_{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 100	nA
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS} = 24 V, V_{GS} = 0 V$ (N-ch)			1	uA
		$V_{DS} = -24 V, V_{GS} = 0 V$ (P-ch)			-1	
On-State Drain Current ^a	$I_{D(on)}$	$I_S = 5 A, V_{GS} = 10 V$ (N-ch)	7.5			A
		$V_{DS} = -5 V, V_{GS} = -10 V$ (P-ch)	-7.5			A
Drain-Source On-Resistance ^a	$r_{DS(on)}$	$V_{GS} = 10 V, I_D = 4.6 A$ (N-ch)			50	m Ω
		$V_{GS} = 4.5 V, I_D = 3.7 A$ (N-ch)			83	
		$V_{GS} = -10 V, I_D = -3.8 A$ (P-ch)			72	m Ω
		$V_{GS} = -4.5 V, I_D = -3.1 A$ (P-ch)			105	
Forward Transconductance ^a	g_{fs}	$V_{DS} = 15 V, I_D = 4.6 A$ (N-ch)		9		S
		$V_{DS} = -15 V, I_D = -3.8 A$ (P-ch)		8		S
Diode Forward Voltage ^a	V_{SD}	$I_S = 1.6 A, V_{GS} = 0 V$ (N-ch)		0.78		V
		$I_S = -1.4 A, V_{GS} = 0 V$ (P-ch)		-0.83		V
Dynamic ^b						
Total Gate Charge	Q_g	N - Channel $V_{DS} = 15 V, V_{GS} = 4.5 V,$ $I_D = 4.6 A$		4.4		nC
Gate-Source Charge	Q_{gs}			1.1		
Gate-Drain Charge	Q_{gd}			2.2		
Turn-On Delay Time	$t_{d(on)}$	N - Channel $V_{DS} = 15 V, R_L = 3.3 \Omega, I_D = 4.6 A,$ $V_{GEN} = 10 V, R_{GEN} = 6 \Omega$		3		ns
Rise Time	t_r			11		
Turn-Off Delay Time	$t_{d(off)}$			17		
Fall Time	t_f			5		
Input Capacitance	C_{iss}	N - Channel $V_{DS} = 15 V, V_{GS} = 0 V, f = 1 \text{ Mhz}$		360		pF
Output Capacitance	C_{oss}			56		
Reverse Transfer Capacitance	C_{rss}			46		
Total Gate Charge	Q_g	P - Channel $V_{DS} = -15 V, V_{GS} = -4.5 V,$ $I_D = -3.8 A$		4.4		nC
Gate-Source Charge	Q_{gs}			0.7		
Gate-Drain Charge	Q_{gd}			2.6		
Turn-On Delay Time	$t_{d(on)}$	P - Channel $V_{DS} = -15 V, R_L = 4 \Omega, I_D = -3.8 A,$ $V_{GEN} = -10 V, R_{GEN} = 6 \Omega$		4		ns
Rise Time	t_r			20		
Turn-Off Delay Time	$t_{d(off)}$			19		
Fall Time	t_f			10		
Input Capacitance	C_{iss}	P - Channel $V_{DS} = -15 V, V_{GS} = 0 V, f = 1 \text{ Mhz}$		467		pF
Output Capacitance	C_{oss}			73		
Reverse Transfer Capacitance	C_{rss}			58		

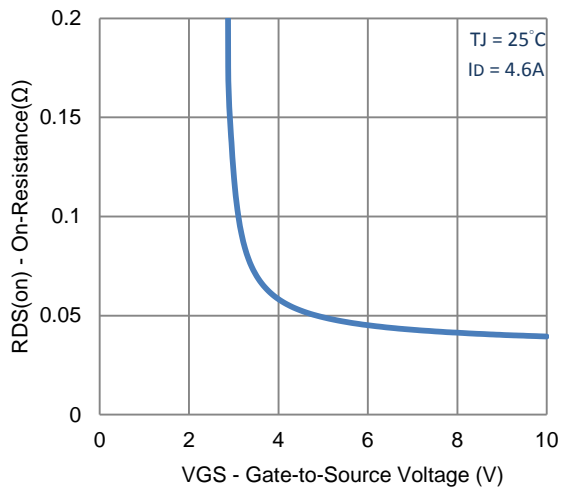
Typical Electrical Characteristics - N-channel



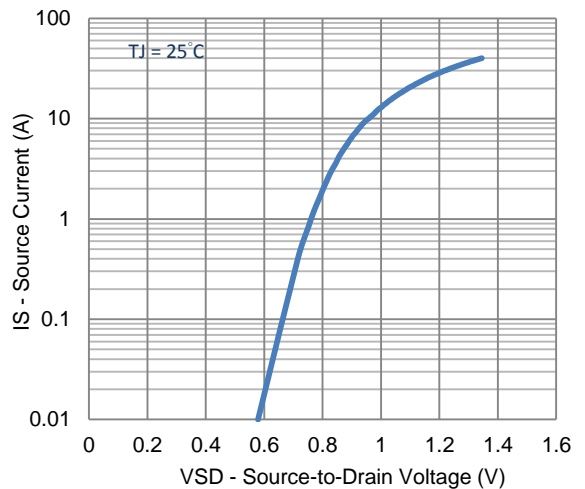
1. On-Resistance vs. Drain Current



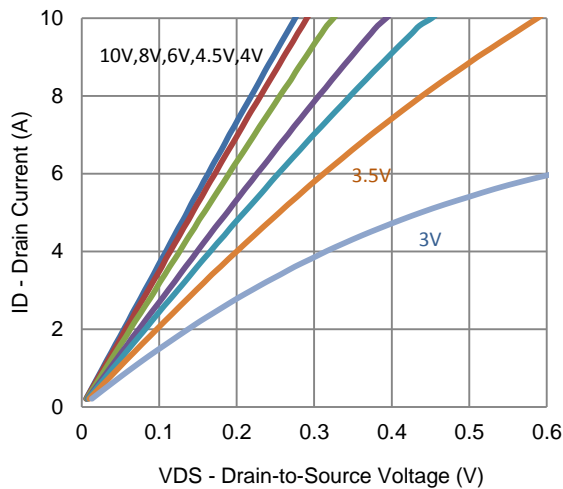
2. Transfer Characteristics



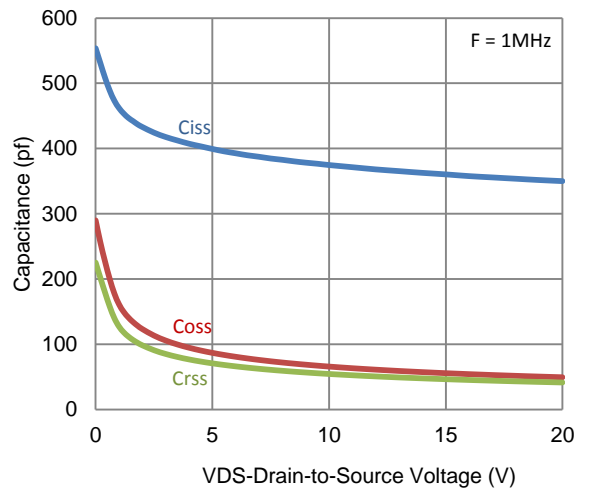
3. On-Resistance vs. Gate-to-Source Voltage



4. Drain-to-Source Forward Voltage

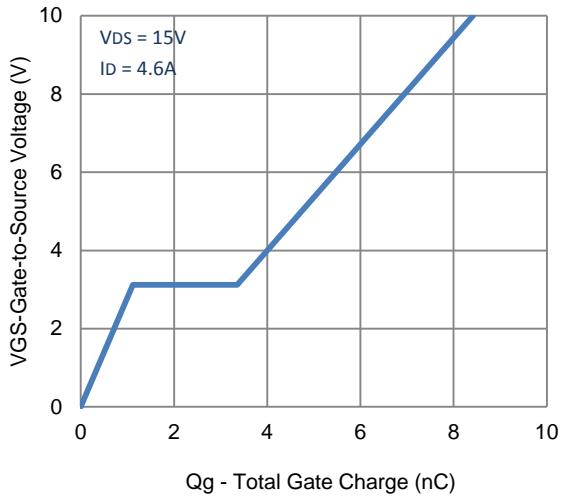


5. Output Characteristics

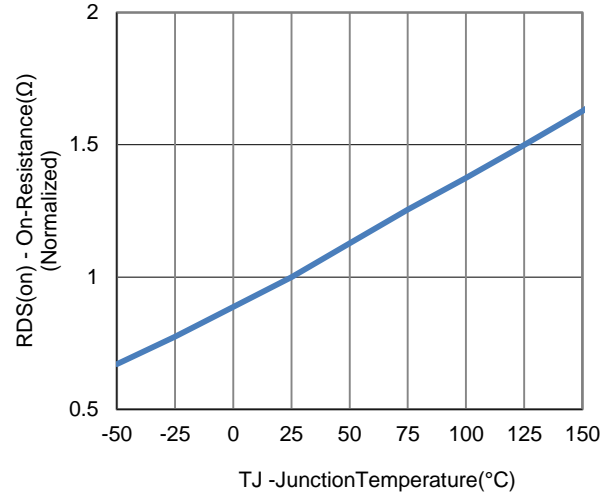


6. Capacitance

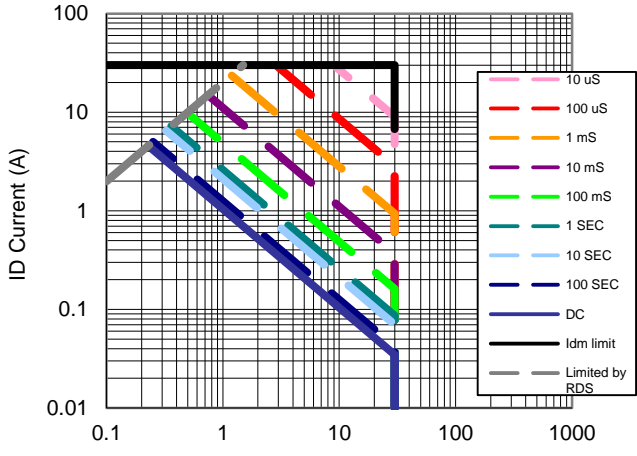
Typical Electrical Characteristics - N-channel



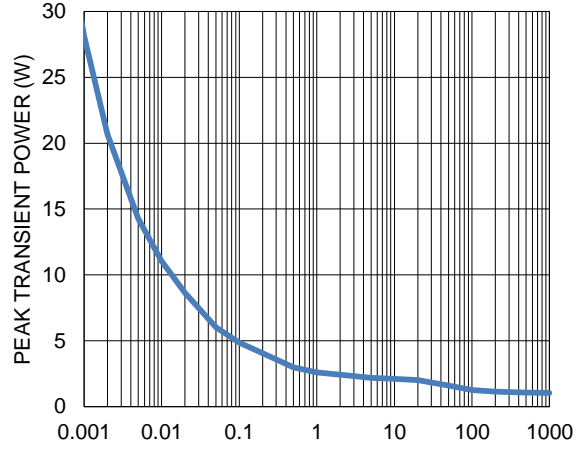
7. Gate Charge



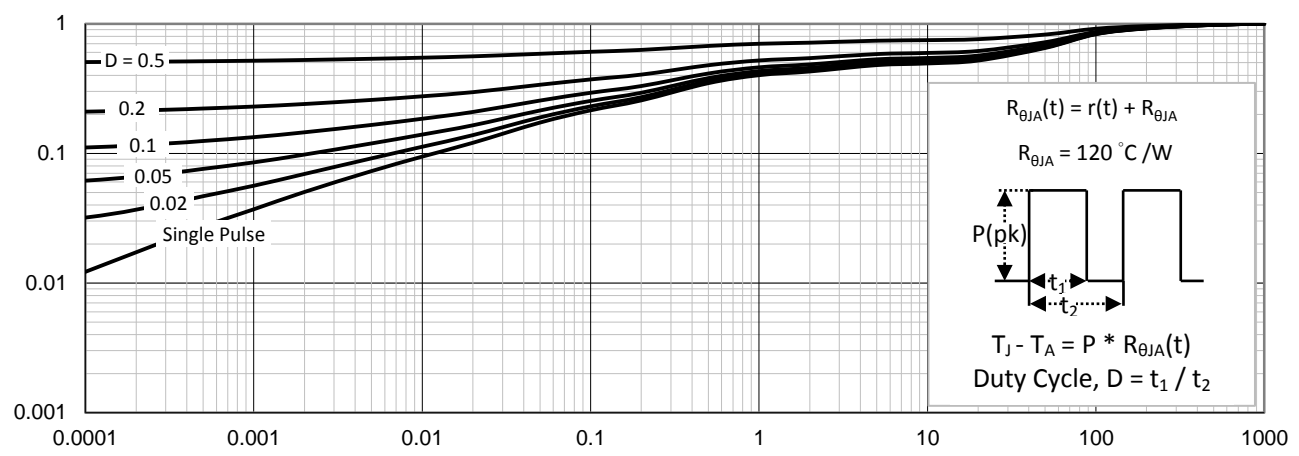
8. Normalized On-Resistance Vs Junction Temperature



9. Safe Operating Area

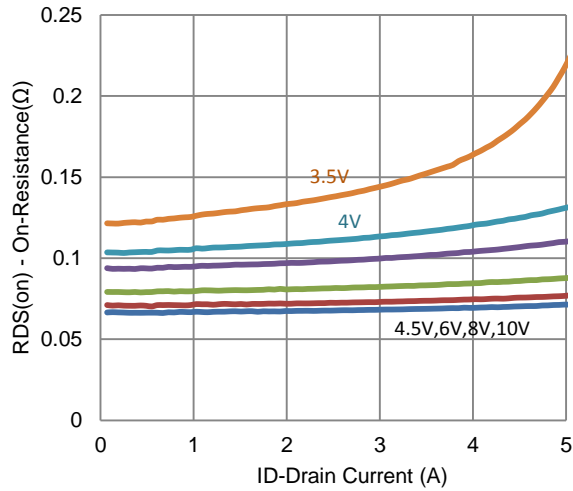


10. Single Pulse Maximum Power Dissipation

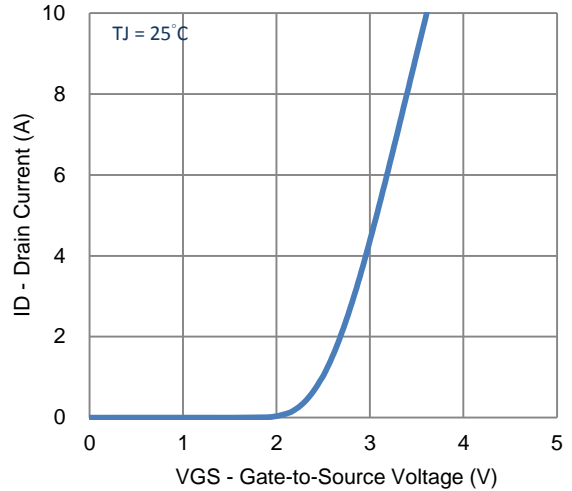


11. Normalized Thermal Transient Junction to Ambient

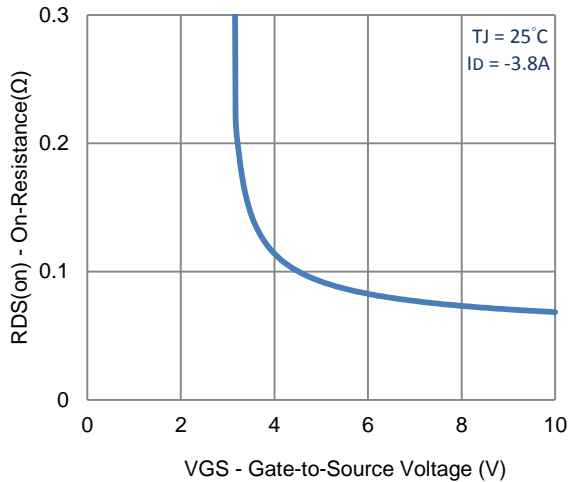
Typical Electrical Characteristics - P-channel



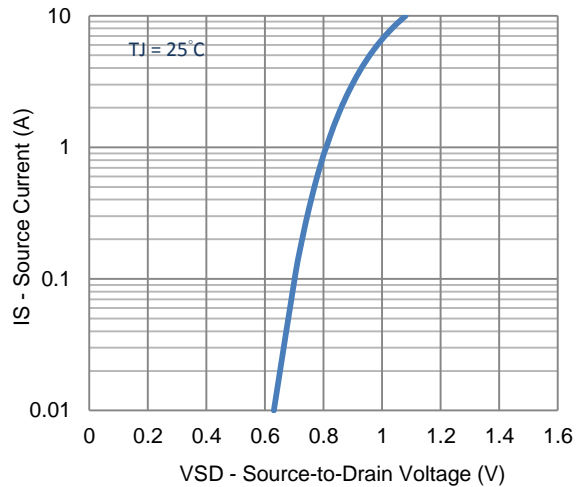
1. On-Resistance vs. Drain Current



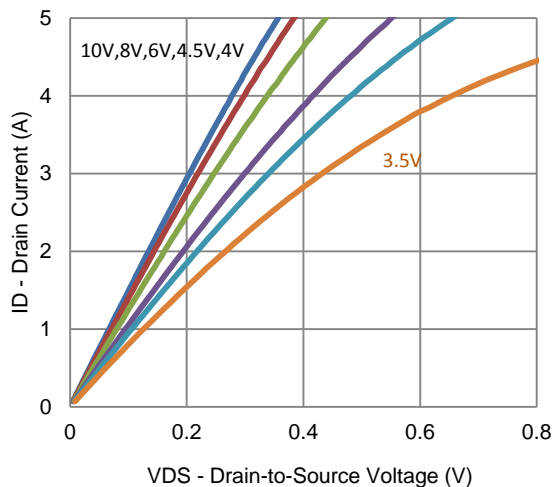
2. Transfer Characteristics



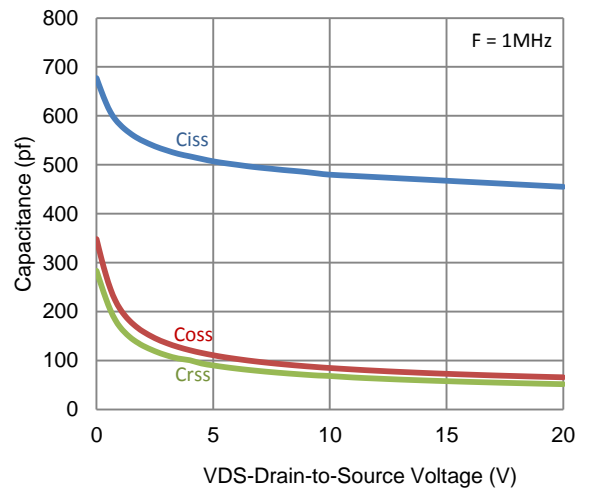
3. On-Resistance vs. Gate-to-Source Voltage



4. Drain-to-Source Forward Voltage

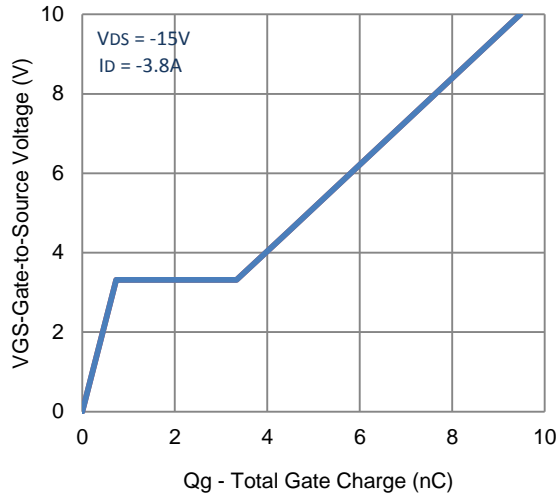


5. Output Characteristics

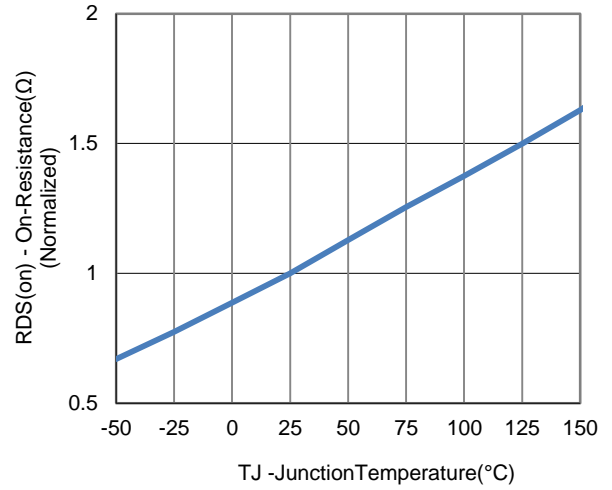


6. Capacitance

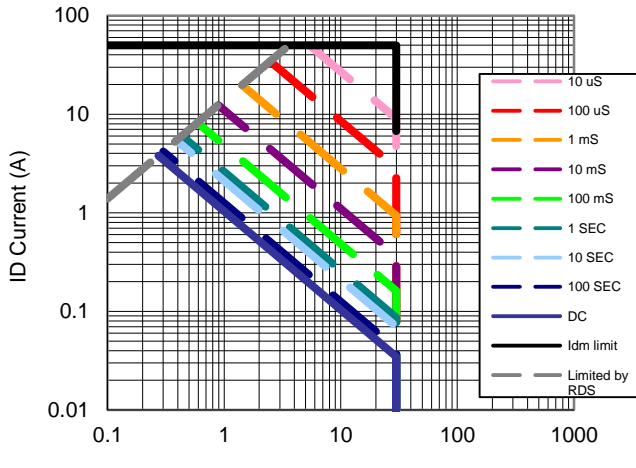
Typical Electrical Characteristics - P-channel



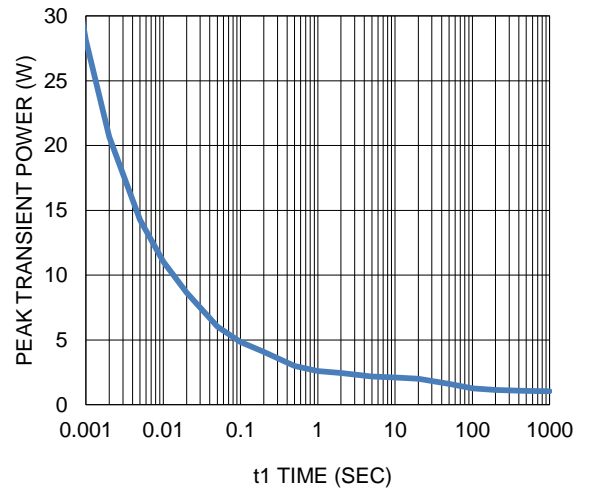
7. Gate Charge



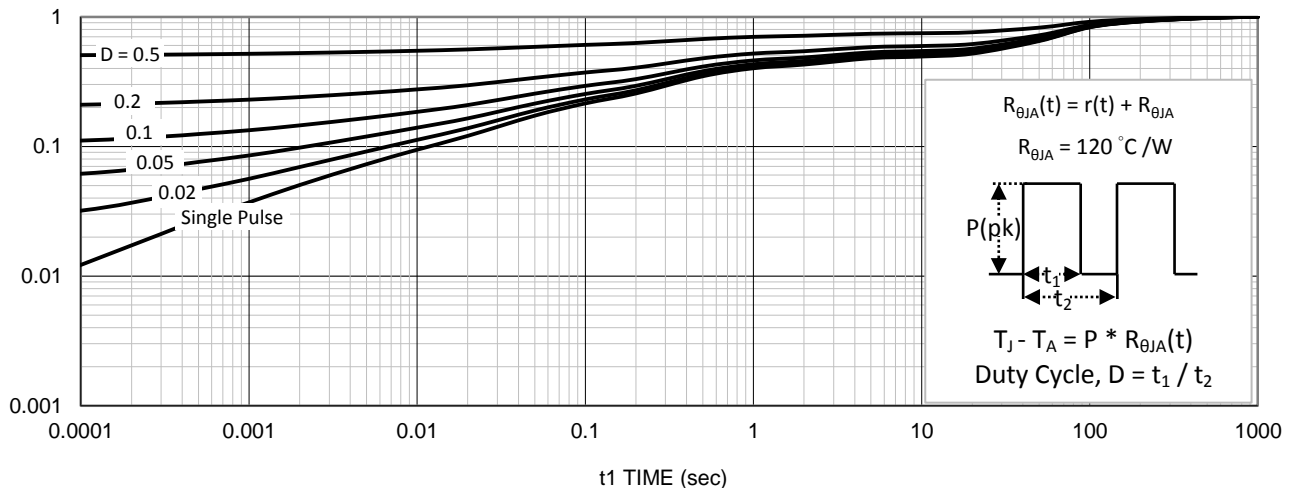
8. Normalized On-Resistance Vs Junction Temperature



9. Safe Operating Area

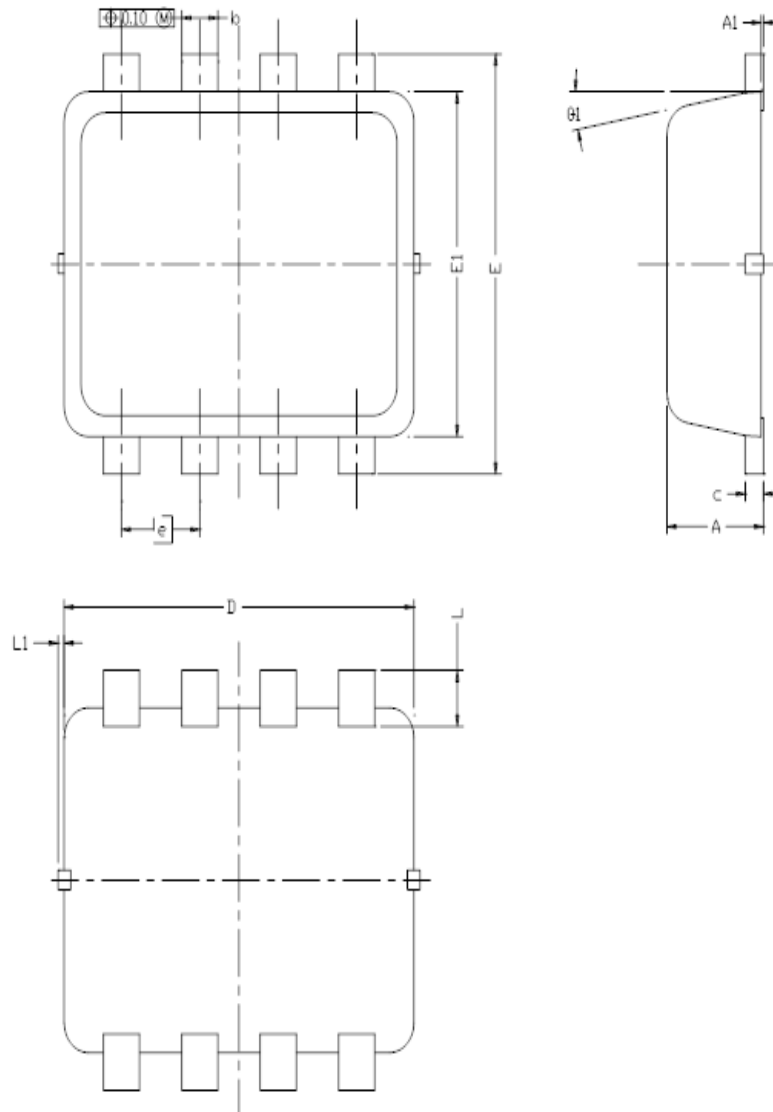


10. Single Pulse Maximum Power Dissipation



11. Normalized Thermal Transient Junction to Ambient

Package Information



DIM.	MILLIMETERS			INCHES		
	MIN	NOM	MAX	MIN	NOM	MAX
A	0.70	0.80	0.90	0.0276	0.0315	0.0354
A1	0.00	---	0.05	0.000	---	0.002
b	0.24	0.30	0.35	0.009	0.012	0.014
c	0.10	0.152	0.25	0.004	0.006	0.010
D	3.00 BSC			0.118 BSC		
D1	2.475 BSC			0.093 BSC		
D2	1.063 BSC			0.042 BSC		
D3	0.225 BSC			0.009 BSC		
E	3.20 BSC			0.126 BSC		
E1	3.00 BSC			0.118 BSC		
E2	1.813 BSC			0.069 BSC		
E3	0.525 BSC			0.023 BSC		
e	0.65 BSC			0.026 BSC		
L	0.30	0.40	0.50	0.0118	0.0157	0.0197
L1	0	---	0.100	0	---	0.004
-	0?	10?	12?	0?	10?	12?